

PD100Mx0MP Series

■ Features

1. Compact, thin type (3.0×1.5×2.2mm)
2. Surface mount type
3. 2-way mounting available: top view/side view
4. Reflow soldering
5. Transparent resin: **PD100MC0MP/PD100MC0MP1**
Visible light cut-off resin: **PD100MF0MP/PD100MF0MP1**
6. Taped model

■ Applications

1. Cameras
2. Pagers
3. Potable game machine

■ Model Line-up

Resin		Mount type	Packing
Transparent resin	Visible light cut-off resin		
PD100MF0MP	PD100MF0MP	Side view	2 000pcs./1reel
PD100MF0MP1	PD100MF0MP1	Top view	1 500pcs./1reel

■ Absolute Maximum Ratings (Ta=25°C)

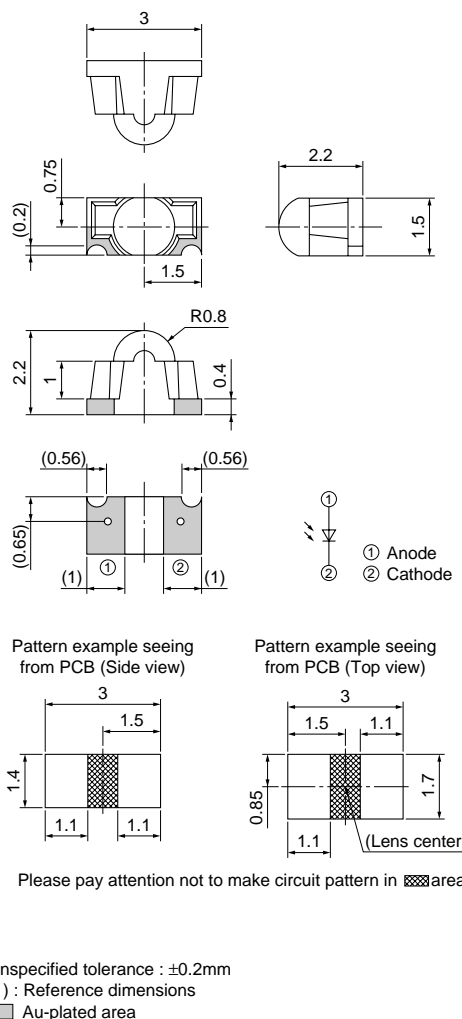
Parameter	Symbol	Rating	Unit
Reverse voltage	V _R	20	V
Power dissipation	P	75	mW
Operating temperature	T _{opr}	−30 to +85	°C
Storage temperature	T _{stg}	−40 to +95	°C
*1 Soldering temperature	T _{sol}	240	°C

*1 MAX. for 10 s

Compact, Surface Mount Type Photodiode

■ Outline Dimensions

(Unit : mm)



■ Electro-optical Characteristics

(Ta=25°C)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Short circuit current	PD100MC0MP/PD100MC0MP1	Isc	Ev=100 lx	0.6	0.9	1.2	μA
	PD100MF0MP/PD100MF0MP1			0.4	0.6	0.8	
Dark current		Id	VR=10V, EV=0	—	—	10	nA
Terminal capacitance		Ct	VR=15V, f=1MHz	—	—	10	pF
Peak sensitivity wavelength	PD100MC0MP/PD100MC0MP1	λp	—	—	820	—	nm
	PD100MF0MP/PD100MF0MP1			—	850	—	
Response time		tr, tr	VR=15V, RL=180Ω	—	10	—	ns
Half intensity angle		Δθ	—	—	20	—	°

*2 Ev: Illuminance by CIE standard light source A (tungsten lamp)

Fig.1 Power Dissipation vs. Ambient Temperature

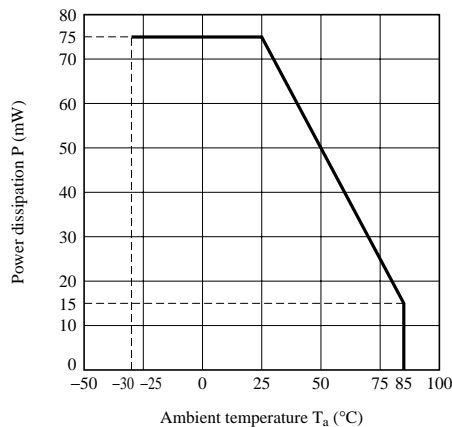


Fig.2 Spectral Sensitivity

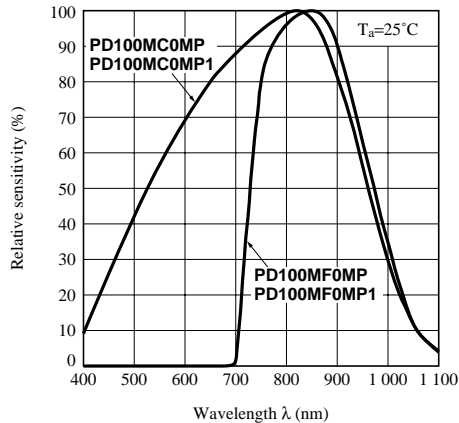


Fig.3 Dark Current vs. Ambient Temperature

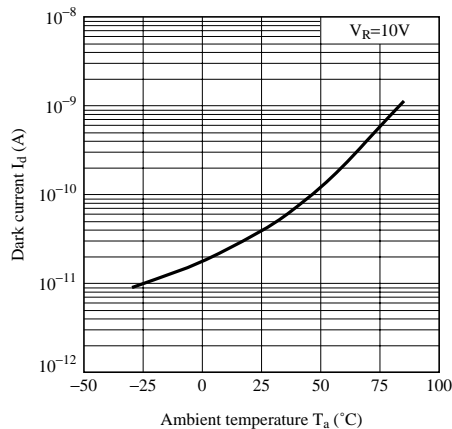


Fig.4 Dark Current vs. Reverse Voltage

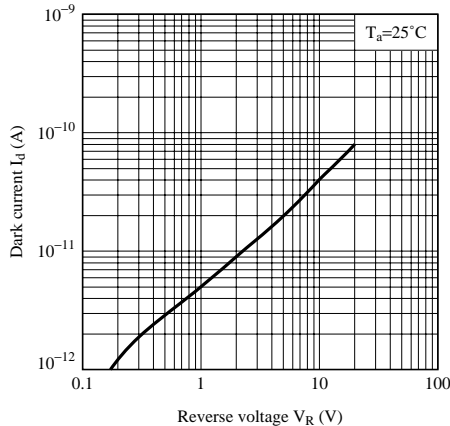
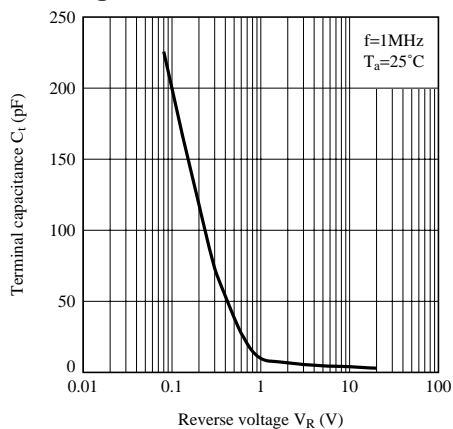
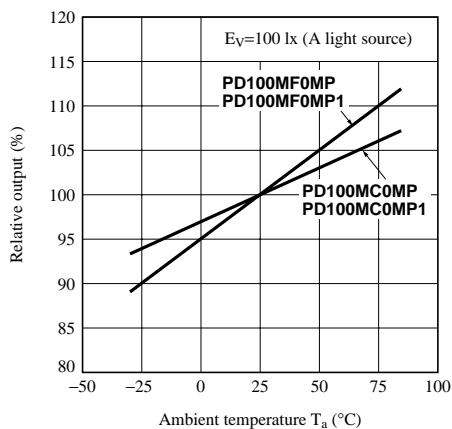
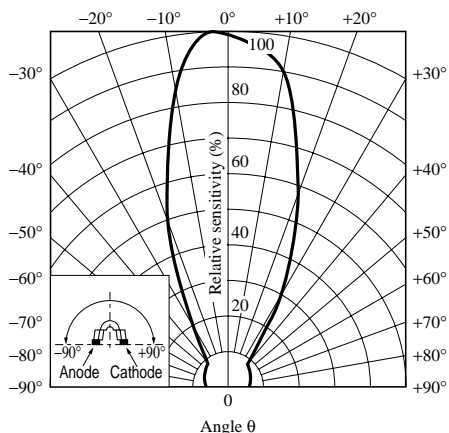
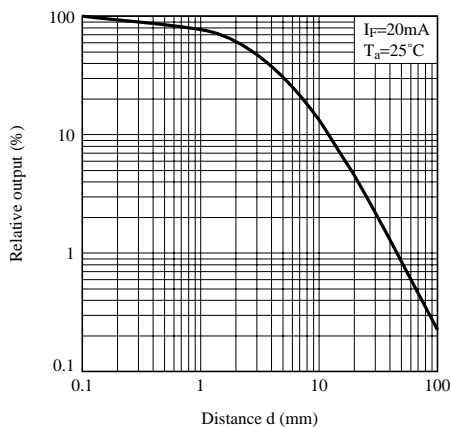
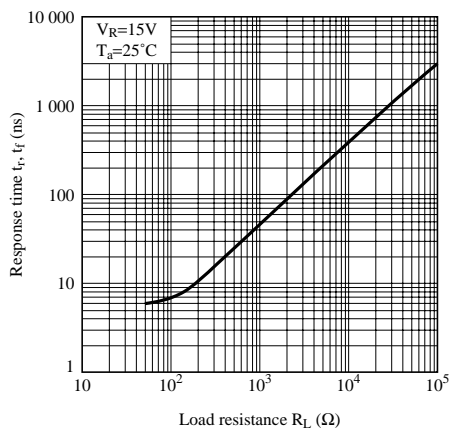
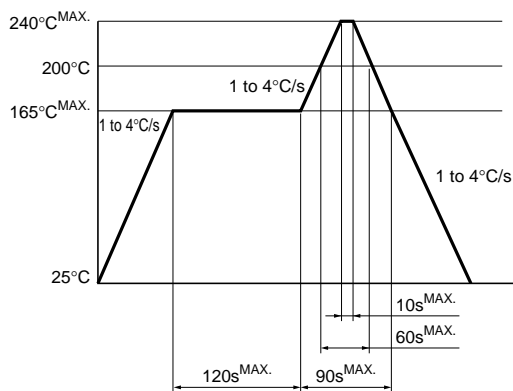


Fig.5 Terminal Capacitance vs. Reverse Voltage**Fig.6 Relative Output vs. Ambient Temperature****Fig.7 Sensitivity Diagram****Fig.8 Relative Output vs. Distance (Emitter:GL100MNIMP)****Fig.9 Response Time vs. Load Resistance****Fig.10 Reflow Soldering**

Only one time soldering is recommended within the temperature profile shown below.



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